

IRF510STRR-VB Datasheet N-Channel 100-V (D-S) MOSFET

PRODUCT	SUMMARY						
V _{(BR)DSS} (V)	R _{DS(on)} (Ω)	I _D (A)					
100	0.100 at V _{GS} = 10 V	20					

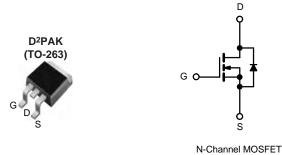
FEATURES

- Trench Power MOSFET
- 175 °C Junction Temperature
- Low Thermal Resistance Package
- 100 % R_g Tested

APPLICATIONS

• Isolated DC/DC Converters





ABSOLUTE MAXIMUM RATINGS	T _C = 25 °C, unless oth	erwise noted		
Parameter		Symbol	Limit	Unit
Drain-Source Voltage		V _{DS}	100	V
Gate-Source Voltage		V _{GS}	± 20	v
Continuous Drain Current (T _J = 175 °C)	T _C = 25 °C	1-	20	
	T _C = 125 °C	I _D	16	A
Pulsed Drain Current		I _{DM}	70	A
Avalanche Current	L = 0.1 mH	I _{AS}	20	
Single Pulse Avalanche Energy ^b		E _{AS}	200	mJ
Maximum Power Dissipation ^b	T _C = 25 °C	Р	105	14/
	T _A = 25 °C ^d	– P _D –	3.75	- W
Operating Junction and Storage Temperature Range		T _J , T _{sta}	- 55 to 175	°C

THERMAL RESISTANCE RATINGS								
Parameter		Symbol	Limit Unit 40					
Junction-to-Ambient	PCB Mount (TO-263) ^d	R _{thJA}	40	°C ///				
Junction-to-Case (Drain)		R _{thJC}	0.4	Unit °C/W				

Notes:

- a. Package limited.
- b. Duty cycle \leq 1 %.
- c. See SOA curve for voltage derating.

d. When Mounted on 1" square PCB (FR-4 material).

SPECIFICATIONS $T_J = 25^{\circ}$	C, unless o	therwise noted							
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit			
Static	•								
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$\begin{tabular}{ c c c c c c c } \hline Test Conditions & Min. & Typ. & Max. & Un \\ \hline & & & & & & & & & & & & & & & & & &$	V						
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1		3	v			
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA			
		$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1				
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$			50	μA			
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	120			А			
		V _{GS} = 10 V, I _D = 20 A	0.100						
Drain-Source On-State Resistance ^a	r _{DS(on)}	V _{GS} = 10 V, I _D = 20 A, T _J = 125 °C		0.110		Ω			
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 20 \text{ A}, \text{ T}_{J} = 175 \text{ °C}$ 0.120							
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 20 A	25			S			
Dynamic ^b									
Input Capacitance	C _{iss}			950					
Output Capacitance	C _{oss}	V _{GS} = 0 V, V _{DS} = 25 V, f = 1 MHz		280		pF			
Reverse Transfer Capacitance	C _{rss}		110						
Total Gate Charge ^c	$\begin{tabular}{ c c c c c c } \hline Q_g & Q_{gs} & V_{DS} = 100 V, V_{GS} = 10 V, I_D = 65 A & 4.8 $								
Gate-Source Charge ^c		nC							
Gate-Drain Charge ^c					15				
Gate Resistance	Rg		0.5	1.7	3.3	Ω			
Turn-On Delay Time ^c	$ \begin{array}{c c c c c c c c c c c c c c c c c c c $								
Rise Time ^c									
Turn-Off Delay Time ^c	t _{d(off)}	$\text{I}_{\text{D}}\cong$ 65 A, V_{GEN} = 10 V, R_{g} = 2.5 Ω		25		ns			
Fall Time ^c	t _f			50					
Source-Drain Diode Ratings and Ch	aracteristics 7	_C = 25 °C ^b			l				
Continuous Current	۱ _S				65				
Pulsed Current	I _{SM}				140	А			
Forward Voltage ^a	V _{SD}			1.5	V				
Reverse Recovery Time	t _{rr}			130	200	ns			
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 50 A, di/dt = 100 A/μs		8	12	А			
Reverse Recovery Charge	Q _{rr}			0.52	1.2	μC			

Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

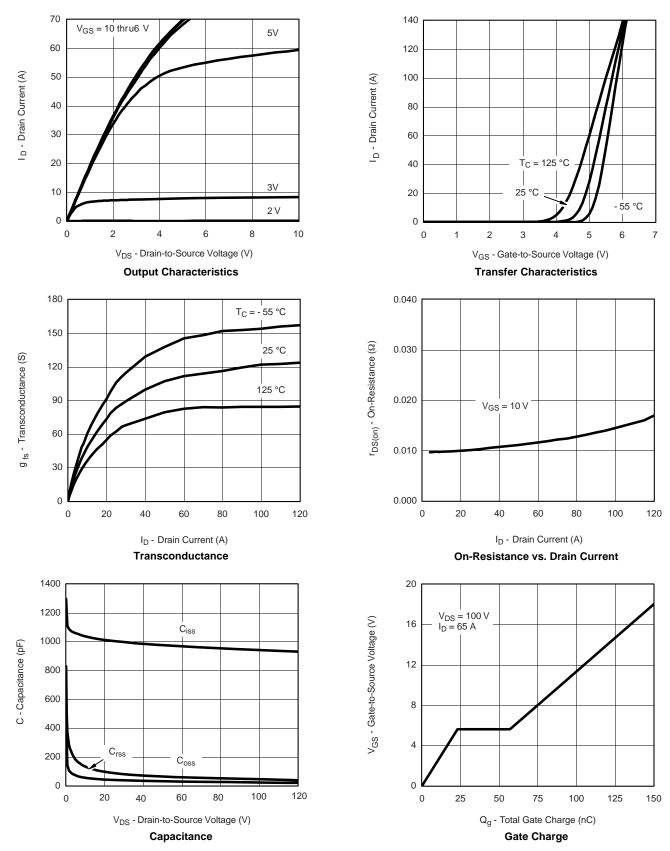
c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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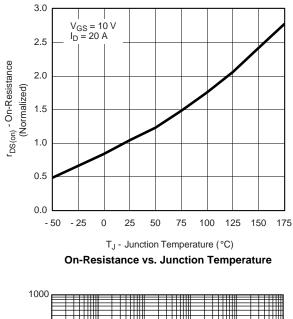


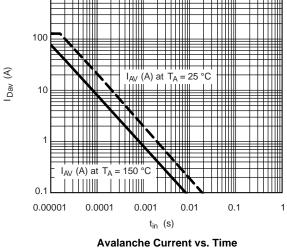


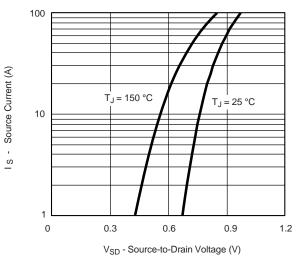
服务热线:400-655-8788



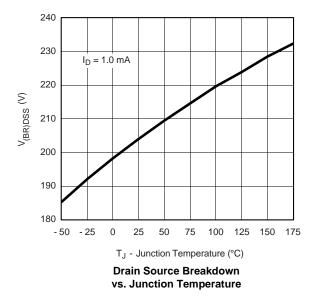
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted







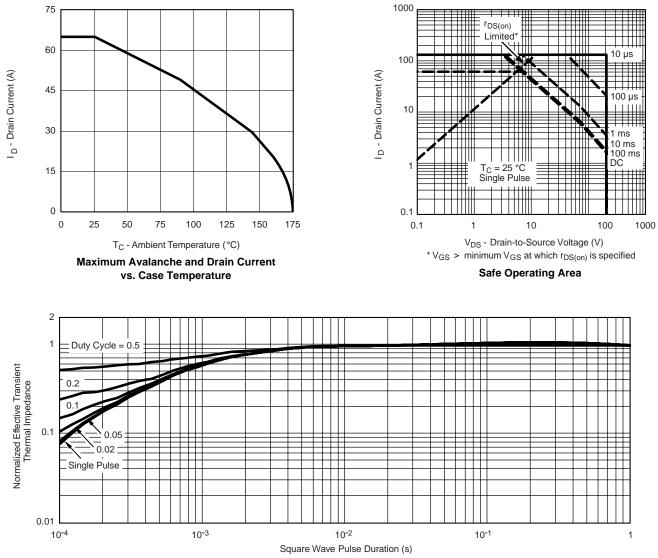
Source-Drain Diode Forward Voltage



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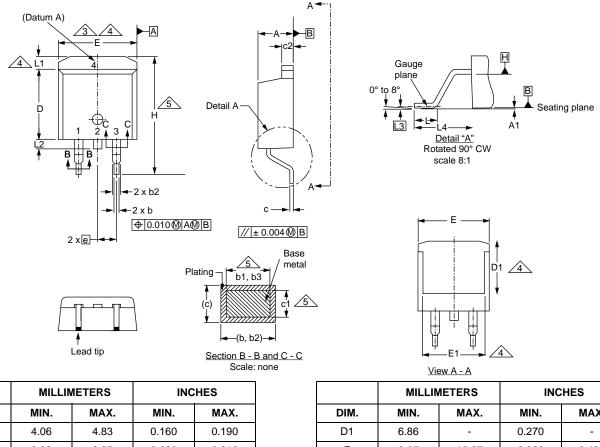
THERMAL RATINGS



Normalized Thermal Transient Impedance, Junction-to-Case



TO-263AB (HIGH VOLTAGE)



	MILLIMETERS		INCHES			MILLI	MILLIMETERS		
DIM.	MIN.	MAX.	MIN.	MAX.	DIM.	IM. MIN.	MAX.	MIN.	1
А	4.06	4.83	0.160	0.190	D1	01 6.86	-	0.270	
A1	0.00	0.25	0.000	0.010	E	E 9.65	10.67	0.380	
b	0.51	0.99	0.020	0.039	E1	6.22	-	0.245	
b1	0.51	0.89	0.020	0.035	е	e 2.54	2.54 BSC		0
b2	1.14	1.78	0.045	0.070	Н	H 14.61	15.88	0.575	Ī
b3	1.14	1.73	0.045	0.068	L	L 1.78	2.79	0.070	
С	0.38	0.74	0.015	0.029	L1	_1 -	1.65	-	Ī
c1	0.38	0.58	0.015	0.023	L2	_2 -	1.78	-	Ī
c2	1.14	1.65	0.045	0.065	L3	_3 0.25	0.25 BSC		0
D	8.38	9.65	0.330	0.380	L4	4 4.78	5.28	0.188	T
ECN: S-82 DWG: 597	2110-Rev. A, 0	15-Sep-08	•		<u>.</u>			•	-
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Notes

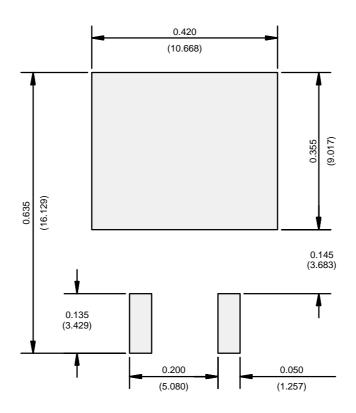
- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimensions are shown in millimeters (inches).

- 4. Thermal PAD contour optional within dimension E, L1, D1 and E1.
- 5. Dimension b1 and c1 apply to base metal only.
- 6. Datum A and B to be determined at datum plane H.
- 7. Outline conforms to JEDEC outline to TO-263AB.

^{3.} Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.



RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)



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